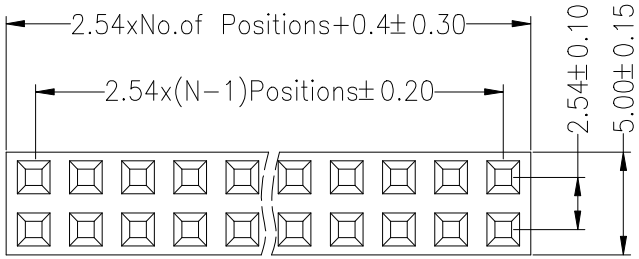
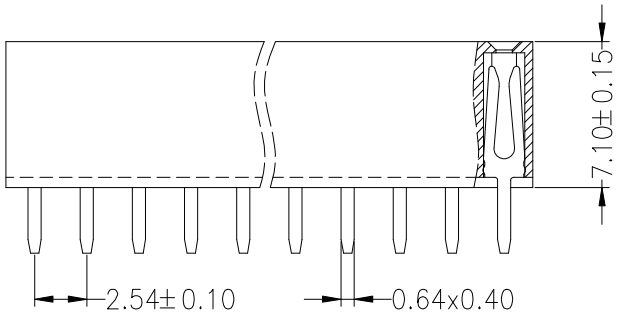
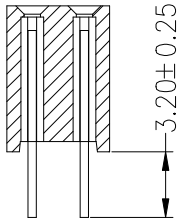
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 260℃±5° 5S



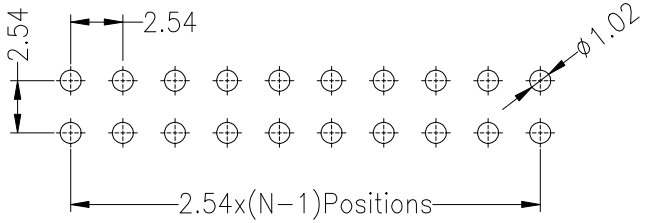




Ordering Information

227102 XX X N XX S Y X 0X

- XX — No.of Pins Per Row 2~40
- X — Insulator Material Option
  - A=BK−PBT
  - C=BK−PA6T
  - E=BK−PA9T
  - F=BK−LCP
- XX — Contact Plating
  - G1:Gold Flash
  - G2:1.5U" Gold
  - G3:2U" Gold
  - G4:3U" Gold
  - G5:5U" Gold
  - G6:10U" Gold
  - G7:15U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- X — Packing
  - A=Tray
  - T=Tube
  - P=Tube+Cap
  - R=Reel+Cap
  - M=Reel+Mylar



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2021.12.09	NEW DRAWING	

OPERATION		DRAW	Liu Miao	21.12.09	SCALE	FIT
X.X	± 0.30				UNIT	mm
X.XX	± 0.20	CHECK			SIZE	A4
X.XXX	± 0.10				SHEET	1/1
Angle	± 3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	227102XXXNXXSYX0X
TITLE:	2.54PF H7.1mm 2xNpin 180° DIP